Overview

HP ZBook Ultra 14" G1a Mobile Workstation PC



		Left	
1	Internal microphones (2)	5	Extra Large Clickpad
2	Webcam and IR Camera	6	Security lock slot (Lock sold separately.)
3	Webcam LED	7	USB Type-A 10Gbps
4	Fingerprint reader / Power button	8	USB 3.1 Gen 1 charging port
		9	Woofer



Overview



Right

- USB 3.1 Gen 1 charging port 2
 - USB Type-C™ with Thunderbolt™

- Audio combo jack
- **HDMI 2.1** 4
- 5 Woofer



Overview

At A Glance

- Preinstall Windows 11, Ubuntu 24.04, or FreeDOS
- Choice of AMD Ryzen™ AI Max+ PRO 395, or AMD Ryzen™ AI Max PRO 390, 385, or 380
- Display include your choice of 35.56 cm (14") diagonal, FHD Non-Touch or QHD Touch
- Integrated Radeon 8060S Graphics, Radeon 8050S Graphics, or Radeon 8040S Graphics
- Enhanced security features including TPM2.0, HP Sure Start self-healing BIOS, HP Client Security,
- Self-Encrypting storage drives, and Fingerprint reader"
- Undergoes MIL-STD 810H tests [1]
- Weight starting at OLED 1.599 kg (3.52 lbs,), FHD 1.568 Kg (3.45 lbs,)
- Battery life up to x hours and x minutes
- Supports wireless LAN for connectivity on the go
- Up to 4 TB Solid State Drives
- Up to 128 GB shared system memory
- Up to 96 GB dedicated graphics memory
- 5MP webcam, IR camera for face authentication with Windows Hello [5,12]
- Full size, backlit, Keyboard and Extra Large Clickpad, multi-touch gestures enabled, taps enabled as default

NOTE: See important legal disclosures for all listed specs in their respective features sections.



Features

OPERATING SYSTEM

Preinstalled OS Windows 11 Pro1

Windows 11 Home - HP recommends Windows 11 Pro for business 1

Windows 11 Home Single Language - HP recommends Windows 11 Pro for business 1

Windows 11 Pro (Windows 11 Enterprise or Windows 10 Enterprise available with a Volume Licensing Agreement)¹

FreeDOS

Ubuntu 24.04 LTS

¹ Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated and enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.

NOTE: Your product does not support Windows 8 or Windows 7. In accordance with Microsoft's support policy, HP does not support the Windows® 8 or Windows 7 operating system on products configured with Intel® and AMD® 7th generation and forward processors or provide any Windows® 8 or Windows 7 drivers on http://www.support.hp.com. A full list of HP products and the Windows 10 versions tested is available on the HP support website. https://support.hp.com/us-en/document/c05195282

PROCESSOR

AMD Ryzen™ AI Max+ PRO 395 processor with PRO technologies (16 core/32 thread, 16MB L2 Cache, 64MB L3 cache, up to 5.1 GHz max boost) c^{1,2,3}

AMD Ryzen™ AI Max PRO 390 Processor with PRO technologies (12 core/24 thread, 12MB L2 Cache, 64MB L3 cache, up to 5.0 GHz max boost) 1,2,3

AMD Ryzen™ AI Max PRO 385 Processor with PRO technologies (8 core/16 thread, 8MB L2 Cache, 32MB L3 cache, up to 5.0 GHz max boost) 1,2,3

AMD Ryzen™ AI Max PRO 380 Processor with PRO technologies (6 core/12 thread, 6MB L2 Cache, 16MB L3 cache, up to 4.9 GHz max boost) 1,2,3

AMD Ryzen[™] AI Max+ PRO 395 processor (16 core/32 thread, 16MB L2 Cache, 64MB L3 cache, up to 5.1 GHz max boost) ^{1,2,3} AMD Ryzen[™] AI Max PRO 390 Processor (12 core/24 thread, 12MB L2 Cache, 64MB L3 cache, up to 5.0 GHz max boost) ^{1,2,3} AMD Ryzen[™] AI Max PRO 385 Processor (8 core/16 thread, 8MB L2 Cache, 32MB L3 cache, up to 5.0 GHz max boost) ^{1,2,3}

¹ Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. AMD's numbering, branding and/or naming is not a measurement of higher performance.



Features

⁴ In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on http://www.support.hp.com.

⁵ Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.

⁶Features and software that require a NPU may require software purchase, subscription or enablement by a software or platform provider, and third party software may have specific configuration or compatibility requirements. Potential NPU inferencing performance varies by use, configuration, and other factors.

CHIPSET

Chipset is integrated with processor

GRAPHICS

Integrated

AMD Radeon™ Graphics

Name	Graphics Model	Graphics Core Count
AMD Ryzen™ AI Max+ PRO 395	Radeon 8060S Graphics	40
AMD Ryzen™ Al Max+ PRO 390	Radeon 8050S Graphics	32
AMD Ryzen™ AI Max+ PRO 385	Radeon 8050S Graphics	32
AMD Ryzen™ Al Max+ PRO 380	Radeon 8040S Graphics	16

Supports

HDMI2.1, DP2.1



QuickSpecs

Features

DISPLAY

Non-touch

35.6 cm (14") diagonal, WUXGA (1920 x 1200), UWVA, Anti-Glare, 400 nits, sRGB 100% 1,3

Touch

 35.6 cm (14") diagonal, 2.8K (2880 x 1800), OLED, UWVA, Touch, 120Hz (VRR), BrightView, Low Blue Light, 400 nits, DCI-P3 100% 1.3.4.5

Display Size

14"

35.6 cm (14")

¹HD content required to view HD images.

² HDMI cable sold separately.

³Resolutions are dependent upon monitor capability, and resolution and color depth settings.

⁴HP Sure View Reflect integrated privacy screen is an optional feature that must be configured at purchase and is designed to function in landscape orientation.

⁵Actual brightness will be lower with touchscreen or Sure View.

STORAGE AND DRIVES*

Primary M.2 Storage

4 TB PCIe® Gen4 x4 NVMe™ M.2 TLC SSD 2 TB PCIe® Gen4 x4 NVMe™ M.2 TLC SSD 1 TB PCIe® Gen4 x4 NVMe™ M.2 TLC SSD 512 GB PCIe® Gen4 x4 NVMe™ M.2 TLC SSD 512 GB PCIe® Gen4x4 NVMe™ SED TLC OPAL2

* For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 35GB of disk is reserved for system recovery software.

MEMORY

Memory

128 GB LPDDR5X-8533 MT/s RAM 64 GB LPDDR5X-8533 MT/s RAM 32 GB LPDDR5X-8533 MT/s RAM 16 GB LPDDR5X-8533 MT/s RAM



QuickSpecs

Features

Memory Slots

Memory soldered down Supports Dual Channel Memory

NETWORKING/COMMUNICATIONS

WLAN

MediaTek MT7925 1418 Wi-Fi7 + BT5.4 (802.11be 2x2, AMD AIM-T) 1

¹Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, and Windows 11 to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.

Near Field Communication (NFC) module

NFC Mirage WNC XRAV-1

¹Sold separately or as an optional feature.

Miracast

Native Miracast Support

NOTE: Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming.

AUDIO/MULTIMEDIA

Audio

Audio by Poly Studio

4 Integrated stereo speakers

2 Integrated dual array microphone

Speaker Power

1w / 8 OHM Per Speaker

Webcam

5MP+Infrared camera

Sensors

Hall Sensor



Features

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Keyboard

HP Premium Keyboard - spill resistant, backlit keyboard

Pointing Devices

Microsoft Precision Touchpad with gesture support; Clickpad with multi-touch gesture support, taps enabled as default with image sensor and glass surface

Function Keys

ESC: system information

F1 - Display Switching

F2 - Blank or SureView On/Off

F3 - Brightness Down

F4 - Brightness Up

F5 - Blank or Backlit Toggle

F6 - Audio Mute

F7 - Volume Down

F8 - Volume Up

F9 - Mic Mute

F10 - Play and Pause

F11 - Programmable key

F12 – Home

Power Button (with LED)

Delete

Hidden Keys

Fn+R - Break

Fn+S - Sys Rq

Fn+C - Scroll Lock

Fn+E - Insert

Fn+W - Pause

SOFTWARE AND SECURITY

Software

HP PC Hardware Diagnostics UEFI

HP PC Hardware Diagnostics Windows

HP Privacy Settings

HP Touchpoint Customizer

Buy Microsoft Office (Sold separately)

HP Hotkey Support

HPX

HP Connection Optimizer¹⁰



Features

HP Support Assistant¹ HP Services Scan³⁴

Manageability Features

HP Connect for Microsoft Endpoint Manager²⁶ HP Manageability Integration Kit¹²

Security Management HP Wolf Security for Business ²⁹

HP Sure Sense¹⁹

HP Sure Run Gen4³¹

HP Sure Recover Gen4 with Embedded Reimaging¹⁴

HP Sure Start Gen6¹⁶

HP Client Security Manager¹⁸

HP TPM Configuration Utility

Secured-core PC capable

TPM 2.0 Embedded Security Chip

HP Image Assistant Gen4.6

POWER

Power Supply

140 W USB Type-C® slim adapter

Battery

HP XL-Long Life 4 cell, 74.5Whr Polymer^{3,4}



¹ HP Support Assistant - Requires Windows and Internet Access.

¹⁰ HP Connection Optimizer requires Windows 10 and Windows 11.

¹² HP Manageability Integration Kit can be downloaded from https://ftp.ext.hp.com/pub/caps-softpaq/cmit/HPMIK.html.

¹⁴ HP Sure Recover Gen5 with Embedded Reimaging is an optional feature which requires Windows 10 and higher must be configured at purchase. You must back up important files, data, photos, videos, etc. before use to avoid loss of data. Network based recovery using Wi-Fi is only available on PCs with Intel Wi-Fi Module

¹⁶ HP Sure Start Gen7 is available on select HP PCs and requires Windows 10 and higher

¹⁸ HP Client Security Manager Gen7 requires Windows and is available on select HP Pro, Elite and ZBook PCs. See product specifications for details.

¹⁹ HP Sure Sense is available on select HP PCs with Windows 10 Pro, Windows 10 Enterprise, Windows 11 Pro, or Windows 11 Enterprise OS.

²⁶ HP Connect for Microsoft Endpoint Manager is available from the Azure Market Place for HP Pro, Elite, Z and Point-of-Sale PCs managed with Microsoft Endpoint Manager. Subscription to Microsoft Endpoint Manager required and sold separately. Network connection required.

²⁹ HP Wolf Security for Business requires Windows 10 or higher, includes various HP security features and is available on HP Pro, Elite, RPOS and Workstation products. See product details for included security features and OS requirement.

³¹ HP Sure Run Gen5 is available on select HP PCs and requires Windows 10 and higher.

³⁴ HP Services Scan is provided with Windows Update on select products and will check entitlement on each hardware device to determine if an HP TechPulse-enabled service has been purchased, and will download applicable software automatically. HP TechPulse is a telemetry and analytics platform that provides critical data around devices and applications. For full system requirements or to disable this feature, please visit http://www.hpdaas.com/requirements . Not applicable in China.

Features

Power Cord

3-wire plug - 1m

Battery life

Up to 14.5 Hours1

¹ MM25 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See www.bapco.com for additional details.

³Battery is internal and not replaceable by customer. Serviceable by warranty.

⁴ For new batteries, actual battery Watt-hours (Wh) may differ from the design capacity and may have a full charge capacity that differs by up to 10, which is typical for lithium-ion batteries. Battery capacity naturally decreases over time and with use, depending on several factors such as battery health management settings, shelf life, temperature, environment, loaded apps, features, system configuration, and power settings.

WEIGHTS & DIMENSIONS

Product Dimensions (w x d x h)

12.29x 8.45x 0.71 in 31.22x21.465x1.81 cm

Weights*

Product Weight

FHD Starting at 1.568 Kg (3.46 lbs.) OLED Starting at 1.599 Kg (3.52 lbs.)

*Weight will vary by configuration. Does not include power adapter.

PORTS/SLOTS

2 x Thunderbolt™ 4 with USB Type-C® 40Gbps signaling rate (USB Power Delivery, DisplayPort™ 2.1)*

1x USB Type-C[®] 10Gbps signaling rate (USB Power Delivery, DisplayPort™ 2.1)

1 x HDMI 2.1**

1 x headphone/mic combo jack

1 x USB Type-A 10Gbps signaling rate (1 charging)

1 x Security lock slot

*USB 20Gbps is not available with Thunderbolt™ 4.

**HDMI cable sold separately.



QuickSpecs

Features

SERVICE AND SUPPORT

TBD

Certification and Compliance

EPEAT® 2019 registered where applicable. EPEAT® registration varies by country. See www.epeat.net for registration status by country.

EPEAT® 2019 Gold

TCO 10 Certified

EPEAT Climate Badge Early Adopter - Worldwide - SRP

GS Mark - EMEA - SRP

Low Blue Light Certification - Worldwide - SRP

Sustainable Impact Specifications



¹ Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. Status varies by country. Visit www.epeat.net for more information.

² External power supplies, power cords, cables and peripherals are not low halogen. Service parts obtained after purchase may not be low halogen.

Technical Specifications – System Unit

SYSTEM UNIT

Stand-Alone Power Requirements (AC Power)

Nominal Operating Voltage 28V

Average Operating Power

Integrated graphics RDNA3.5

Discrete Graphics

Max Operating Power UMA < 55W

Temperature

 Operating
 32° to 95° F (0° to 35° C)

 Non-operating
 -4°F to 149°F (-20°C to 65°C)

Relative Humidity

Operating

Non-operating . 60°C (140°F) and 95% humidity for 6 hours

. 30°C (86°F) and 95% humidity for 8 hours

Shock

OperatingOperating: 40G, 2msNon-operatingNon-operating: 240G, 2ms

Random Vibration

Operating1.043 grmsNon-operating3.5 grms

Altitude (unpressurized)

Operating
Non-operating

Planned Industry Standard Certifications

Regulatory Model Number HSTNS-I001

UL CSA

FCC Compliance

ENERGY STAR® Yes **EPEAT** Yes

ICES

Australia /

NZ A-Tick ComplianceWe usually use RCM for naming, which corresponds to the C-Tick compliance.

ccc

Japan VCCI Compliance

KC BSMI

CE Marking Compliance

BNCI or BELUS Currently, we do not apply for this country's certification separately; instead, we

focus on applying for EAC certification.

CIT These is not within our scope of confirmation; CIT appears to be related to the PCB

board.

GOST Currently, we do not apply for this country's certification separately; instead, we



HP ZBook Ultra 14" G1a Mobile Workstation PC

Technical Specifications – System Unit

focus on applying for EAC certification.

Saudi Arabian Compliance (ICCP)
SABS
UKRSERTCOMPUTER

We apply for NRCS not SABS

- Configurations of the HP ProBook 430 G4 that are ENERGY STAR® qualified are identified as HP ProBook 430 G4 ENERGY STAR on HP websites and on http://www.energystar.gov. - System Lead - N - Please, don't change the number between the brackets

- Based on US EPEAT® registration according to IEEE 1680.1-2018 EPEAT®. EPEAT® status varies by country. Visit www.epeat.net for more information. - System Lead - N - Please, don't change the number between the brackets



Technical Specifications – Displays

DISPLAYS

14.0 in 2.8K (2880 x 1800) BrightView UWVA OLED+LBL DCI-P3 100 400 eDP 1.4+PSR2+IOL 120Hz (VRR) bent OLED Touch Panel

Outline Dimensions (W x H) 305.450x197.850(max) **Active Area** 301.824x188.640 (typ)

Weight 139(max) **Diagonal Size** 14"

Surface Treatment Bright View

Touch Enabled

Contrast Ratio 100,000:1(typ) **Refresh Rate** 48~120Hz Brightness 400 (tvp) **Pixel Resolution - Format** RGB Backlight OLED

Pixel Resolution 2880 x 1800 (UWVA) **Color Gamut Coverage** DCI P3 100% **Color Depth** 8 bit + FRC 2 bit **Viewing Angle** UWVA 89/89/89/89

Low Blue Light Yes

Power Consumption (W, EBL@ 150nits max/ 200nits max))

4.42(max)/4.09(max)

14.0 in WUXGA (1920 x 1200) Anti-Glare UWVA sRGB 100 3SB 400 eDP 1.4+PSR2 bent LCD **Panel**

Outline Dimensions (W x H)

307.550x204.860(max) **Active Area** 301.590 X 188.500 (typ)

Weight 200(max) **Diagonal Size** 14

Surface Treatment Anti-Glare **Touch Enabled** No

Contrast Ratio 1200:1 (typ) **Refresh Rate** 60 (typ) **Brightness** 400 (typ) **Pixel Resolution - Format** RGB Backlight WLED

Pixel Resolution 1920 x 1200 (WUXGA)

Color Gamut Coverage sRGB 100% **Color Depth** 8 bits

Viewing Angle UWVA 89/89/89/89

Low Blue Light No

Power Consumption (W, EBL@ 1.64 (max)/1.97(max)

150nits max/ 200nits max))



Technical Specifications – Storage

CI	rn	D	Λ	c	C
31	u	к		ч	С

SSD 512GB 2280 PCIe-4x4 NVMe Three Layer Cell Form Factor M.2 2280

Capacity512GBNAND TypeTLCInterfacePCIe NVMe Gen4X4

Maximum Sequential Read6400 MB/s ±20%Maximum Sequential Write3500 MB/s ±20%Logical Blocks1000215215

Features Pyrite 2.0; TRIM; L1.2

SSD 1TB 2280 PCIe-4x4 NVMe Three Layer Cell Form Factor M.2 2280

Capacity1TBNAND TypeTLC

InterfacePCIe NVMe Gen4X4Maximum Sequential Read6400 MB/s ±20%Maximum Sequential Write5000 MB/s ±20%Logical Blocks2000409264

Features Pyrite 2.0; TRIM; L1.2

SSD 2TB 2280 PCIe-4x4 NVMe Three Layer Cell Form Factor M.2 2280

Capacity 2TB NAND Type TLC

InterfacePCIe NVMe Gen4X4Maximum Sequential Read6400 MB/s ±20%Maximum Sequential Write5000 MB/s ±20%Logical Blocks4000797360

Features Pyrite 2.0; TRIM; L1.2

512GB PCIe-4x4 2280 NVME Self Encrypted OPAL2 Three Layer Cell Solid State Drive Form Factor M.2 2280

Capacity512GBNAND TypeTLC

InterfacePCIe NVMe Gen4X4Maximum Sequential Read6400 MB/s ±20%Maximum Sequential Write3500 MB/s ±20%Logical Blocks1000215215

Features TCG Opal 2.0; TRIM; L1.2

CZL (TBC) Form Factor M.2 2280



HP ZBook Ultra 14" G1a Mobile Workstation PC

Technical Specifications – Storage

Capacity

NAND Type TLC

Interface PCIe NVMe Gen

Maximum Sequential Read Maximum Sequential Write

Logical Blocks Features

4TB PCIe-4x4 2280 NVMe Three Layer Cell double-sided M.2 Solid State Drive Form Factor
Capacity
NAND Type

Logical Blocks

NAND Type
TLC
Interface
PCIe NVMe Gen4X4
Maximum Sequential Read
Maximum Sequential Write
5000 MB/s ±20%

Features Pyrite 2.0; TRIM; L1.2

M.2 2280

8001573552

4TB



Technical Specifications – Networking

NETWORKING / COMMUNICATION

MediaTek MT7925 1418 Wi-Fi7 Wireless LAN Standards + BT5.4 (802.11 be 2x2, AMD AIM-T) [1]

IEEE 802.11b
IEEE 802.11g
IEEE 802.11n
IEEE 802.11ac
IEEE 802.11be
IEEE 802.11d
IEEE 802.11d
IEEE 802.11t
IEEE 802.11h
IEEE 802.11i
IEEE 802.11k
IEEE 802.11r
IEEE 802.11v

IEEE 802.11a

Interoperability Frequency Band Wi-Fi certified 802.11b/g/n/ax/be • 2.402 – 2.482 GHz 802.11a/n/ac/ax/be • 4.9 – 4.95 GHz (Japan) • 5.15 – 5.25 GHz • 5.25 – 5.35 GHz • 5.47 – 5.725 GHz • 5.825 – 5.850 GHz • 5.955 – 6.415 GHz • 6.435 – 6.515 GHz • 6.535 – 6.875 GHz • 6.895 – 7.115 GHz

Data Rates

• 802.11b: 1, 2, 5.5, 11 Mbps

802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11n: max 300Mbps802.11ac : 1733Mbps802.11ax : max 2.4Gbps

• 802.11be: max 2.8Gbps (160MHz)

Modulation

Direct Sequence Spread Spectrum

OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM,

4096QAM



HP ZBook Ultra 14" G1a Mobile Workstation PC

Technical Specifications – Networking

Security[3]

IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g

mode only

AES-CCMP: 128 bit in hardware

802.1x authentication

• WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

 WPA2 certification WPA3 certification • IEEE 802.11i

WAPI

Network Architecture Models Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

Roaming Output Power[2] IEEE 802.11 compliant roaming between access points

• 802.11b, 1Mbps: +17dBm minimum • 802.11q, 6Mpbs: +16dBm minimum • 802.11a, 6Mbps: +17dBm minimum

• 802.11n, MCS7(HT20): +14dBm minimum 802.11n, MCS7(HT40): +13.5dBm minimu • 802.11ac MCS9(VHT20): 13.5dBm minimum

 802.11ac MCS9(VHT40): +13.5dBm minimum 802.11ac MCS9(VHT80): +12.5dBm minimum 802.11ac MCS9(VHT160): +10.5dBm minimum

 802.11ax MCS11(HE20)(6GHz): +11.5dBm minimum • 802.11ax MCS11(HE40)(6GHz): +7.5dBm minimum 802.11ax MCS11(HE80)(6GHz): +7.5dBm minimum 802.11ax MCS11(HE160)(6GHz): +7.5dBm minimum

 802.11be MCS13(EHT20)(6GHz): +11.5dBm 802.11be MCS13(EHT40)(6GHz): +7.5dBm • 802.11be MCS13(EHT80)(6GHz): +7.5dBm 802.11be MCS13(EHT160)(6GHz): +6.5dBm

Power Consumption

Transmit mode 2.7 W

Receive mode 1.8 W

• Idle mode (PSP) 180 mW (WLAN Associated) Idle mode 50 mW (WLAN unassociated)

Connected Standby 10mW

Radio disabled 8 mW

Power Management

ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Receiver Sensitivity[3]

•802.11b, 1Mbps: -93.5dBm maximum



Technical Specifications – Networking

•802.11b, 11Mbps: -85dBm maximum • 802.11a/g, 6Mbps: -90.5dBm maximum 802.11a/q, 54Mbps: -72.5dBm maximum 802.11n, MCS0(HT20): -90dBm maximum 802.11n, MCS7(HT20): -71.5dBm maximum 802.11n, MCS0(HT40): -88.5dBm maximum 802.11n, MCS7(HT40): -68.5dBm maximum 802.11ac, MCS9(VHT20): -88.5dBm maximum 802.11ac, MCS9(VHT40): -65.5dBm maximum • 802.11ac, MCS9(VHT80): -60.5dBm maximum 802.11ac, MCS9(VHT160): -58.5dBm maximum • 802.11ax, MCS11(HE20)(6GHz): -59.5dBm maximum • 802.11ax, MCS11(HE40)(6GHz): -56.5dBm maximum • 802.11ax, MCS11(HE80)(6GHz): -53.5dBm maximum • 802.11ax, MCS11(HE160)(6GHz): -51.5dBm maximum • 802.11be, MCS13(EHT20)(6GHz): -55.5dBm maximum • 802.11be, MCS13(EHT40)(6GHz): -53.5dBm maximum • 802.11be, MCS13(EHT80)(6GHz): -51.5dBm maximum 802.11be, MCS13(EHT160)(6GHz): -48.5dBm maximum

Antenna type

High efficiency antenna with spatial diversity, mounted in the

display enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth

communications

Form Factor PCI-Express M.2 MiniCard

Dimensions 1. Type 1418: 1.67 x 14.0 x 18.0 mm

Weight 1. Type 1418: 1.3g

Operating Voltage 3.3v +/- 9%

Temperature Operating: 14° to 158° F (–10° to 70° C)

Non-operating: -40° to 176° F (-40° to 80° C)

Humidity Operating: 10% to 90% (non-condensing)

Non-operating: 5% to 95% (non-condensing)

Altitude Operating: 0 to 10,000 ft (3,048 m)

Non-operating: 0 to 50,000 ft (15,240 m)

LED Activity LED Amber – Radio OFF; LED OFF – Radio ON

HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1/5.2/5.3/5.4 Wireless Technology



HP ZBook Ultra 14" G1a Mobile Workstation PC

Technical Specifications – Networking

Bluetooth Specification 4.0/4.1/4.2/5.0/5.1/5.2/5.3/5.4 Compliant

Frequency Band 2402 to 2480 MHz

Number of Available Channels Legacy : 0~79 (1 MHz/CH)

BLE: 0~39 (2 MHz/CH)

Data Rates and Throughput Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps

BLE: 1 Mbps data rate; throughput up to 0.2 Mbps

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps,

voice channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Transmit Power The Bluetooth component shall operate as a Class I Bluetooth

device with a maximum transmit power of +15.5 dBm for BR and

+13dBm for EDR.

Power Consumption Peak (Tx): 330 mW

Peak (Rx): 230 mW

Selective Suspend: 17 mW

Bluetooth Software Supported

Link Topology

1. Microsoft Windows Bluetooth Software

2. Linux/Chrome OS Bluetooth Software.

Power Management ACPI and PCI Express compliant power management

802.11 compliant power saving mode

Certifications

Power Management

Certifications

FCC (47 CFR) Part 15C, Section 15.247 & 15.249

ETS 300 328, ETS 300 826

Low Voltage Directive IEC950

UL, CSA, and CE Mark

Bluetooth Profiles Supported BT4.1-ESR 5/6/7 Compliance

LE Link Layer Ping LE Dual Mode LE Link Layer

LE Low Duty Cycle Directed Advertising LE L2CAP Connection Oriented Channels

Train Nudging & Interlaced Scan

BT4.2 ESR08 Compliance

LE Secure Connection- Basic/Full LE Privacy 1.2 -Link Layer Privacy



HP ZBook Ultra 14" G1a Mobile Workstation PC

Technical Specifications – Networking

LE Privacy 1.2 - Extended Scanner Filter Policies

LE Data Packet Length Extension

FAX Profile (FAX)

Basic Imaging Profile (BIP)2 Headset Profile (HSP) Hands Free Profile (HFP)

Advanced Audio Distribution Profile (A2DP)

BT5.2

ESR9/10 Compliance

LE Advertisement Extensions Channel Selection Algo

Limited High Duty Cycle Non-Connectable Advertising

2Mbps LE LE Long Range

BT5.3

Host to Controller Encryption Key Control Enahancements Compliance to the latest Errata Section 12.3 of BT 5.3 specification

¹Wi-Fi 7 requires a Wi-Fi 7 router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 7 is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 7 is supported. Wi-Fi 7 is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

² Check latest software/driver release for updates on supported security features.

³ The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

⁴ Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

NFC NXP NPC300

Dimensions (L x W x H) 17 x 10 x 2.0 mm

Chipset NPC300 System interface I2C

NFC RF standards ISO/IEC 14443 A ISO/IEC 14443 B ISO/IEC 15693

ECMA-340 NFCIP-1 Target and Initiator

ECMA-320 NFCIP-2

ISO/IEC 18092

NFC Forum Support Tag Type 1, Type 2, Type3 and Type 4, NFCIP-1 and NFCIP-2

Reader (PCD-VCD) Mode(1) ISO/IEC 14443 A

ISO/IEC 14443 B ISO/IEC 15693 MIFARE 1K



Technical Specifications – Networking

MIFARE 4K

MIFARE DESFire

FeliCa

Jewel and Topaz cards

Card Emulation (PICC-VICC) ISO/IEC 14443 A

Mode(1) ISO/IEC 14443 B and B'

MIFARE FeliCa

Frequency 13.56 MHz

NFC Modes Supported Reader/Writer, Peer-to-Peer 106, 212, 424, 848 kbps

Operating temperature Operating: 0 °C to 70 °C (32 °F to 158 °F) **Storage temperature** Storage: -20 °C to 125 °C (-4 °F to 257 °F)

Humidity 10-90% operating

5-95% non-operating

Supply Operating voltage 4.35 to 5.25 Volts

I/O Voltage 1.8V or 3.3V

Power Consumption (Booster enable, VBAT = 3.3V, VCC_BOOST = 5V)

(Booster enable, VBAT= 3.3V,

 $VCC_BOOST = 5V$

Mode Power Consumption, Typical

Polling 7.3 mA

Detected Test Tag Type 1 Total 283.8 mA

Net Module 236.8 mA

Detected Test Tag Type 2 Total 288.8 mA

Net Module 241.8 mA

Detected Test Tag Type 3 Total 287.7 mA

Net Module 240.7 mA

Detected Test Tag Type 4 Total 282.3 mA

Net Module 235.3 mA

Antenna Antenna connector, 0.5mm pitch, 7 connector FPC. Antenna

matching is external to module.



Technical Specifications – Audio

AUDIO

HD Stereo Codec Realtek ALC3315

Audio I/O Ports Front: Headset connector supports a CTIA and OMTP style headset and is re-taskable as a Line-in, Line-out,

Microphone-in or Headphone-out port

Internal Speaker 1W class D mono amplifier for internal speaker External speakers.

Amplifier External speakers must be powered

Multi-streaming Capable Playback multi-streaming can be enabled in the audio control panel to allow independent audio

Sampling streams to be sent to/from the jacks or integrated speaker.

Wavetable Syntheses Independent sampling rates for DAC's and ADC's; supports resolutions from 16 to 24-bit; 44.1

k/48k/96k/192kHz

Analog Audio to 192 kHz for DAC and 44.1 kHz to 96 kHz for ADC

of Channels on Line-

Out Yes - Uses OS soft wavetable

Internal Speaker Yes



Technical Specifications – Power

POWER

HP 140W Slim USB-C Straight AC Power Adapter Daisy II

Weight 415g(+/-10g)

Input 100-240Vac

Input Efficiency 81.50% min at 115 Vac/ 230 Vac @5.00V

86.70% min at 115 Vac/ 230 Vac @9.00V 88.00% min at 115 Vac/ 230 Vac @12.00V 89.00% min at 115 Vac/ 230 Vac @15.00V 89.00% min at 115 Vac/ 230 Vac @20.00V 89.00% min at 115 Vac/ 230 Vac @28.00V

Input frequency range 47-63Hz

Input AC current

Output

Output power 5V/15W

9V/27W 12V/60W 15V/75W 20V/100W 28V/140W

Max. 2.5 A at 90 Vac

DC output 5V/9V/12V/15V/20V/28V

Hold-up time 100% load 5ms at 115 Vac input/80% load 10ms at 115 Vac input **Output current limit** 5V/9V/12V/15V/20V<125% max current, 28V<135% max current

AC Inlet Type C6

DC Cable Connector DC Cable MaterialUSB type C
PVC

Connector

Connector C6

Environmental Design

Operating temperature 0° to 35° C (32° to 95° F)

Non-operating (storage) -20° to 85° C (-4° to 185° F)

temperature

Altitude 0 to 5,000 m(0 to 16,400 ft)

Humidity20% to 95%Storage Humidity10% to 95%

EMI and Safety Certifications CE Mark - full compliance with LVD and EMC directives Worldwide

safety standards - IEC60950-1, IEC 62368-1:2014 and IEC62368-1:2018, EN62368-1:2020+A11, UL 62368-1 Agency approvals - C-UL-US, TUV/GS, TUV/PSE, EN55032 Class B, FCC Class B, CISPR32 Class B, CCC, CU(EAC), KCC(Safety+EMC), NOM001 NYCE, NRcan, NRCS, ISC, SEC, PSB, Argentina S-mark, Australia RCM, BIS, BSMI,

UAE, UKCA DoC, Ukraine(CoC+DoC+RoHS+ECO)



Technical Specifications – Environmental

ENVIRONMENTAL DATA

Eco-Label Certifications & declarations

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- IT ECO declaration
- US ENERGY STAR®
- US Federal Energy Management Program (FEMP)
- EPEAT[®] Gold registered in the United States. See http://www.epeat.netfor.registrationstatus in your country.
- TCO Certified
- China Energy Conservation Program (CECP)
- China State Environmental Protection Administration (SEPA)
- Taiwan Green Mark
- Korea Eco-label
- Japan PC Green label*

Sustainable Impact Specifications

- Product Carbon Footprint
- At least 50% ocean bound plastic in the (CPU Fan) and 30% in (Speakers)¹
- At least 35% post-consumer recycled plastic²
- At least 65% recycled metal³
- Low Halogen⁴
- 100% of HP paper-based packaging is from recycled or certified sustainable sources^s
- Bulk packaging available

System Configuration

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Notebook model is based on a "Typically Configured Notebook".

Energy Consumption (in accordance with US ENERGY STAR® test method)

STAR® test method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz	
Normal Operation (Short idle)	12.05 W	12.18 W	11.87 W	
Normal Operation (Long idle)	N/A	N/A	N/A	
Sleep	0.99 W	0.97 W	0.99 W	
Off	0.42 W	0.43 W	0.41 W	

NOTE:

Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family. HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.



Technical Specifications – Environmental				
Heat Dissipation*	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz	
Normal Operation (Short idle)	41 BTU/hr	42 BTU/hr	41 BTU/hr	
Normal Operation (Long idle)	N/A	N/A	N/A	
Sleep	3 BTU/hr	3 BTU/hr	3 BTU/hr	
Off	1 BTU/hr	1 BTU/hr	1 BTU/hr	

***NOTE:** Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)	Sound Power (L _{wad} , bels)	Sound Pressure (L _{pAm} , decibels)
Typically Configured – Idle	2.6	13.7
Fixed Disk – Random writes	2.7	15.5
Optical Drive – Sequential reads	3.2	21.8

Longevity and Upgrading

This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the

Spare parts are available throughout the warranty period and or for up to "5" years after the end of production.

Additional Information

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see www.epeat.net
- Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.
- This product is 96.0% recycle-able when properly disposed of at end of life.

Packaging Materials	External:	PAPER/Corrugated	267 g
		PAPER/Molded Pulp	100 g
		PAPER/Paper	26 g

The plastic packaging material contains at least 0.0% recycled content.

The corrugated paper packaging materials contains at least 50.7% recycled content.

RoHS Compliance

HP Inc. complies fully with materials regulations. We were among the first companies to extend the restrictions in the European Union (EU) Restriction of Hazardous Substances (RoHS) Directive



QuickSpecs

Technical Specifications – Environmental

to our products worldwide through the HP GSE. HP has contributed to the development of related legislation in Europe, as well as China, India, and Vietnam.

We believe the RoHS directive and similar laws play an important role in promoting industry-wide elimination of substances of concern. We have supported the inclusion of additional substances—including PVC, BFRs, and certain phthalates—in future RoHS legislation that pertains to electrical and electronics products.

We met our voluntary objective to achieve worldwide compliance with the new EU RoHS requirements for virtually all relevant products by July 2013, and we will continue to extend the scope of the commitment to include further restricted substances as regulations continue to evolve.

To obtain a copy of the HP RoHS Compliance Statement, see HP RoHS position statement.

Material Usage

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at

https://h20195.www2.hp.com/v2/GetDocument.aspx?docname=c05998906):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Bis(2-Ethylhexyl) phthalate (DEHP)
- Benzyl butyl phthalate (BBP)
- Dibutyl phthalate (DBP)
- Diisobutyl phthalate (DIBP)
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)



QuickSpecs

Technical Specifications – Environmental

Packaging Usage

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

End-of-life Management and Recycling

HP offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to:

https://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c05403198 or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: HP Product Disassembly Instruction Website. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

HP Inc. Corporate Environmental Information

For more information about HP's commitment to the environment:

- Sustainable Impact Report
 - https://h20195.www2.hp.com/v2/GetDocument.aspx?docname=c06040843
- Eco-label certifications
 - https://www.hp.com/us-en/sustainable-impact/documentreports.html#filters_documents_reports-=document_typetype_energy_star,type_epeat,type_tcolS0
- ISO 14001 certificates
 - https://h20195.www2.hp.com/v2/GetDocument.aspx?docname=c04777932

Footnotes

- Percentage of ocean-bound plastic contained in each component varies by product.
 Ocean Bound plastic is expressed as a percentage of the total weight plastic. Ocean Bound plastic is based on the definition set by the UL2809 standard.
- 2. Recycled plastic is expressed as a percentage of the total weight plastic. Post-consumer recycled is based on the definition set in the EPEAT standard for computers, IEEE 1680.1-2018 standard.
- 3. Recycled metal is expressed as a percentage of the total weight of the metal according to ISO 14021 definitions for metal parts over 25 grams.
- 4. External power supplies, WWAN modules, power cords, cables and peripherals excluded. Service parts obtained after purchase may not be Low Halogen.
- HP paper and fiber-based packaging for PCs, displays, home and office print, and supplies is reported by suppliers as recycled or certified, with a minimum of 97% by volume verified by HP. Packaging is the box that comes with the product and all paperbased materials inside the box. Packaging for personal systems accessories and spare



QuickSpecs

Technical Specifications – Environmental

parts is not included. Plastic cushions are made from >90% recycled plastic.



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Technical Specifications – Options

OPTIONS

Category	Description	Part Number
Audio/Video	TDB	TDB
Cases	TDB	TDB
Docking	TDB	TDB
Hub	TDB	TDB
Adapter	TDB	TDB
Keyboard/Combo	TDB	TDB
Mouse	TDB	TDB
Power	TDB	TDB
Commodity	TDB	TDB



CHANGELOG

Date of change	Version History		Description of change
March 17, 2025	From v1 to v2	Changed	ENVIRONMENTAL DATA section
March 21, 2025	From v2 to v3	Changed	Format

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